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10542040 - GAU: 1795

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Application Number		10542040
	Filing Date		2008-02-06
	First Named Inventor	John Mize	
	Art Unit	1795	
	Examiner Name	Jason Berman	
	Attorney Docket Number	H0004870.70759 US -4015	

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Examiner Initial*	Cite No	Patent Number	Kind Code ¹	Issue Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
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	2	5993594	A	1999-11-30	Lam Research Corporation	
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U.S. PATENT APPLICATION PUBLICATIONS

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FOREIGN PATENT DOCUMENTS								
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